# 54F540,54F541,74F540,74F541

54F540 54F541 74F540 74F541 Octal Buffer/Line Driver with TRI-STATE(RM)
Outputs



Literature Number: SNOS202A

# 54F/74F540 ◆ 54F/74F541 Octal Buffer/Line Driver with TRI-STATE® Outputs

## **General Description**

The 'F540 and 'F541 are similar in function to the 'F240 and 'F244 respectively, except that the inputs and outputs are on opposite sides of the package (see Connection Diagrams). This pinout arrangement makes these devices especially useful as output ports for microprocessors, allowing ease of layout and greater PC board density.

## **Features**

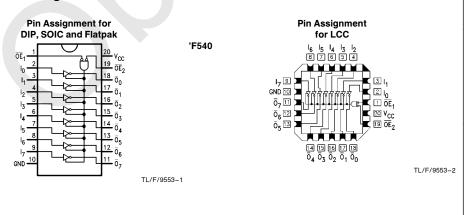
- TRI-STATE outputs drive bus lines
- Inputs and outputs opposite side of package, allowing easier interface to microprocessors

| Commercial        | Military          | Package<br>Number | Package Description                               |
|-------------------|-------------------|-------------------|---|
| 74F540PC          |                   | N20A              | 20-Lead (0.300" Wide) Molded Dual-In-Line         |
|                   | 54F540DM (Note 2) | J20A              | 20-Lead Ceramic Dual-In-Line                      |
| 74F540SC (Note 1) |                   | M20B              | 20-Lead (0.300" Wide) Molded Small Outline, JEDEC |
| 74F540SJ (Note 1) |                   | M20D              | 20-Lead (0.300" Wide) Molded Small Outline, EIAJ  |
|                   | 54F540FM (Note 2) | W20A              | 20-Lead Cerpack                                   |
|                   | 54F540LM (Note 2) | E20A              | 20-Lead Ceramic Leadless Chip Carrier, Type C     |
| 74F541PC          |                   | N20A              | 20-Lead (0.300" Wide) Molded Dual-In-Line         |
|                   | 54F541DM (Note 2) | J20A              | 20-Lead Ceramic Dual-In-Line                      |
| 74F541SC (Note 1) |                   | M20B              | 20-Lead (0.300" Wide) Molded Small Outline, JEDEC |
| 74F541SJ (Note 1) |                   | M20D              | 20-Lead (0.300" Wide) Molded Small Outline, EIAJ  |
|                   | 54F541FM (Note 2) | W20A              | 20-Lead Cerpack                                   |
|                   | 54F541LM (Note 2) | E20A              | 20-Lead Ceramic Leadless Chip Carrier, Type C     |

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

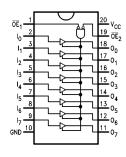
Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

## **Connection Diagrams**

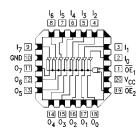


TRI-STATE® is a registered trademark of National Semiconductor Corporation

# **Connection Diagrams** (Continued)



'F541



TL/F/9553-4

TL/F/9553-5

# **Unit Loading/Fan Out**

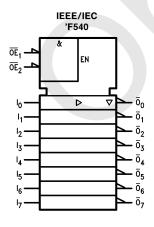
|                                    |  | 54F/74F          |   |  |  |
|------------------------------------|--|------------------|---|--|--|
| Pin Names                          | Description                                | U.L.<br>HIGH/LOW | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |  |  |
| $\overline{OE}_1, \overline{OE}_2$ | TRI-STATE Output Enable Input (Active LOW) | 1.0/1.0          | 20 μA/ -0.6 mA  |  |  |
| In                                 | Inputs                                     | 1.0/1.0          | 20 μA/ -0.6 mA  |  |  |
| $O_n, \overline{O}_n$              | Outputs                                    | 600/106.6 (80)   | -12 mA/64 mA (48 mA)  |  |  |

# **Truth Table**

|   |                 | Inputs            | Outputs |       |       |  |
|---|-----------------|-------------------|---------|-------|-------|--|
|   | ŌE <sub>1</sub> | $\overline{OE}_2$ | ı       | 'F540 | 'F541 |  |
| ſ | L               | L                 | Н       | L     | Н     |  |
|   | Н               | Χ                 | X       | Z     | Z     |  |
|   | Χ               | Н                 | X       | Z     | Z     |  |
|   | L               | L                 | L       | Н     | L     |  |

- H = HIGH Voltage Level
  L = LOW Voltage Level
  X = Immaterial
  Z = High Impedance

# **Logic Diagrams**



IEEE/IEC 'F541 0E<sub>1</sub> -EN ŌĒ₂·

TL/F/9553-6

TL/F/9553-3

### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \text{Storage Temperature} & -65^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \text{Ambient Temperature under Bias} & -55^{\circ}\text{C to} + 125^{\circ}\text{C} \\ \text{Junction Temperature under Bias} & -55^{\circ}\text{C to} + 175^{\circ}\text{C} \\ \text{Plastic} & -55^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \end{array}$ 

V<sub>CC</sub> Pin Potential to

Ground Pin -0.5V to +7.0V Input Voltage (Note 2) -0.5V to +7.0V Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$ 

Current Applied to Output

in LOW State (Max) twice the rated I<sub>OL</sub> (mA)

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# Recommended Operating Conditions

Free Air Ambient Temperature

Military  $-55^{\circ}\text{C to} + 125^{\circ}\text{C}$ Commercial  $0^{\circ}\text{C to} + 70^{\circ}\text{C}$ 

Supply Voltage

Military + 4.5V to + 5.5V Commercial + 4.5V to + 5.5V

## **DC Electrical Characteristics**

| Symbol           | Parameter                            |  | 54F/74F                         |     |              | Units | V <sub>CC</sub> | Conditions  |  |
|------------------|--------------------------------------|--|---------------------------------|-----|--------------|-------|-----------------|---|--|
| Symbol           |                                      |  | Min                             | Тур | Max          | Onits | VCC             | Conditions  |  |
| V <sub>IH</sub>  | Input HIGH Voltage                   |  | 2.0                             |     |              | V     |                 | Recognized as a HIGH Signal   |  |
| $V_{IL}$         | Input LOW Voltage                    |  |                                 |     | 0.8          | V     |                 | Recognized as a LOW Signal  |  |
| V <sub>CD</sub>  | Input Clamp Diode Vo                 | oltage   |                                 |     | -1.2         | V     | Min             | $I_{\text{IN}} = -18  \text{mA}$  |  |
| V <sub>OH</sub>  | Output HIGH<br>Voltage               | 54F 10% V <sub>CC</sub><br>54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub><br>74F 5% V <sub>CC</sub> | 2.4<br>2.0<br>2.4<br>2.0<br>2.7 |     |              | V     | Min             | $\begin{split} I_{OH} &= -3 \text{ mA} \\ I_{OH} &= -12 \text{ mA} \\ I_{OH} &= -3 \text{ mA} \\ I_{OH} &= -15 \text{ mA} \\ I_{OH} &= -3 \text{ mA} \end{split}$ |  |
| V <sub>OL</sub>  | Output LOW<br>Voltage                | 54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub>   | \                               |     | 0.55<br>0.55 | ٧     | Min             | I <sub>OL</sub> = 48 mA<br>I <sub>OL</sub> = 64 mA  |  |
| I <sub>IH</sub>  | Input HIGH<br>Current                | 54F<br>74F   |                                 |     | 20.0<br>5.0  | μΑ    | Max             | V <sub>IN</sub> = 2.7V  |  |
| I <sub>BVI</sub> | Input HIGH Current<br>Breakdown Test | 54F<br>74F   |                                 |     | 100<br>7.0   | μΑ    | Max             | V <sub>IN</sub> = 7.0V  |  |
| I <sub>CEX</sub> | Output HIGH<br>Leakage Current       | 54F<br>74F   |                                 |     | 250<br>50    | μΑ    | Max             | $V_{OUT} = V_{CC}$  |  |
| V <sub>ID</sub>  | Input Leakage<br>Test                | 74F  | 4.75                            |     |              | ٧     | 0.0             | $I_{\text{ID}} = 1.9  \mu\text{A}$ All Other Pins Grounded  |  |
| I <sub>OD</sub>  | Output Leakage<br>Circuit Current    | 74F  |                                 |     | 3.75         | μΑ    | 0.0             | V <sub>IOD</sub> = 150 mV<br>All Other Pins Grounded  |  |
| I <sub>IL</sub>  | Input LOW Current                    |  |                                 |     | -0.6         | mA    | Max             | V <sub>IN</sub> = 0.5V  |  |
| l <sub>OZH</sub> | Output Leakage Current               |  |                                 |     | 50           | μΑ    | Max             | V <sub>OUT</sub> = 2.7V   |  |
| l <sub>OZL</sub> | Output Leakage Current               |  |                                 |     | -50          | μΑ    | Max             | V <sub>OUT</sub> = 0.5V   |  |
| Ios              | Output Short-Circuit Current         |  | -100                            |     | -225         | mA    | Max             | $V_{OUT} = 0V$  |  |
| I <sub>ZZ</sub>  | Bus Drainage Test                    |  |                                 |     | 500          | μΑ    | 0.0V            | V <sub>OUT</sub> = 5.25V  |  |

## DC Electrical Characteristics (Continued)

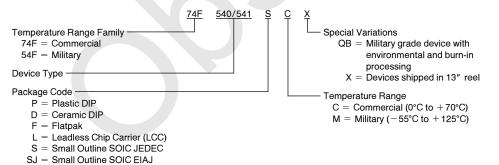
| Symbol           | Parameter                    |     | 54F/74F |     | Units | V <sub>CC</sub> | Conditions              |  |
|------------------|------------------------------|-----|---------|-----|-------|-----------------|-------------------------|--|
| Oymboi           | rananeter                    | Min | Тур     | Max | Onits | •00             |                         |  |
| Icch             | Power Supply Current ('F540) |     | 11      | 20  | mA    | Max             | V <sub>O</sub> = HIGH   |  |
| I <sub>CCL</sub> | Power Supply Current ('F540) |     | 53      | 75  | mA    | Max             | $V_O = LOW$             |  |
| I <sub>CCZ</sub> | Power Supply Current ('F540) |     | 31      | 45  | mA    | Max             | V <sub>O</sub> = HIGH Z |  |
| Icch             | Power Supply Current ('F541) |     | 26      | 35  | mA    | Max             | V <sub>O</sub> = HIGH   |  |
| ICCL             | Power Supply Current ('F541) |     | 55      | 75  | mA    | Max             | $V_O = LOW$             |  |
| I <sub>CCZ</sub> | Power Supply Current ('F541) |     | 31      | 55  | mA    | Max             | V <sub>O</sub> = HIGH Z |  |

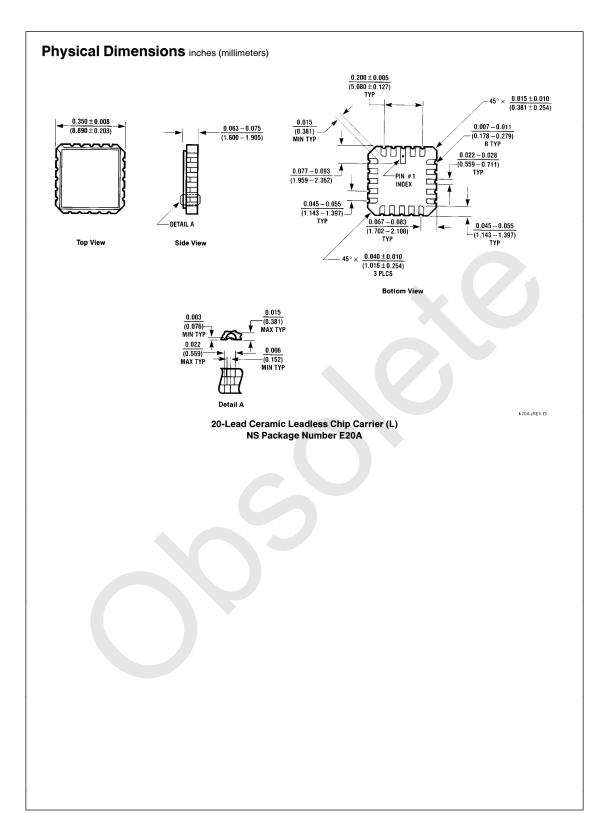
## **AC Electrical Characteristics**

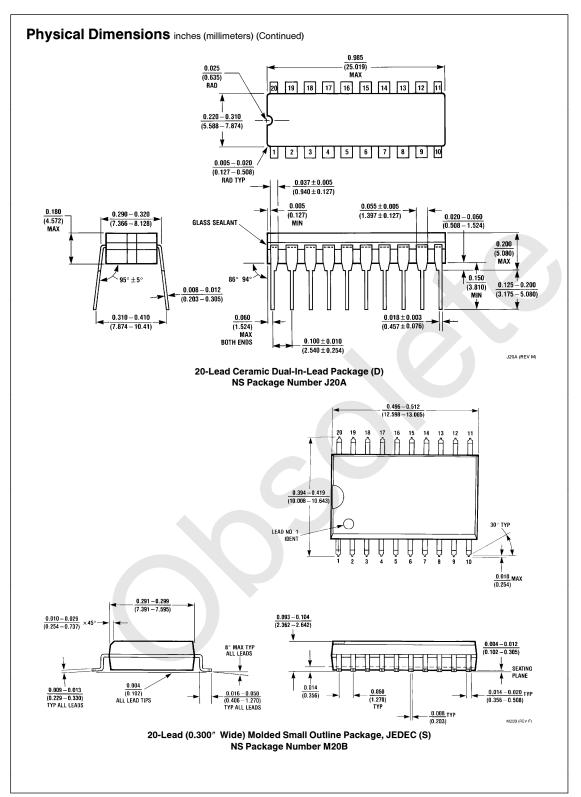
|                                      |   |            |            |             | 54F  T <sub>A</sub> , V <sub>CC</sub> = Mil  C <sub>L</sub> = 50 pF |             | 74F  T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF |             | Units |
|--------------------------------------|---|------------|------------|-------------|---|-------------|--|-------------|-------|
| Symbol                               | Parameter                                   |            |            |             |   |             |  |             |       |
|                                      |   | Min        | Тур        | Max         | Min   | Max         | Min  | Max         |       |
| t <sub>PLH</sub>                     | Propagation Delay<br>Data to Output ('F540) | 1.5<br>1.0 | 3.0<br>2.0 | 5.0<br>4.0  | 1.0<br>1.0  | 6.0<br>4.5  | 1.0<br>1.0   | 5.5<br>4.0  | ns    |
| t <sub>PZH</sub>                     | Output Enable Time ('F540)                  | 2.5<br>3.5 | 4.9<br>5.8 | 8.0<br>10.0 | 2.5<br>3.5  | 9.0<br>11.0 | 2.5<br>3.5   | 8.5<br>10.5 | ns    |
| t <sub>PHZ</sub>                     | Output Disable Time ('F540)                 | 1.5<br>1.0 | 3.4<br>2.5 | 6.0<br>5.5  | 1.5<br>1.0  | 7.0<br>7.5  | 1.5<br>1.0   | 6.5<br>6.0  |       |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>Data to Output ('F541) | 1.5<br>1.5 | 3.3<br>2.7 | 5.5<br>5.5  |   |             | 1.5<br>1.5   | 6.0<br>6.0  | ns    |
| t <sub>PZH</sub>                     | Output Enable Time ('F541)                  | 3.0<br>3.5 | 5.8<br>6.1 | 8.0<br>8.5  |   |             | 2.5<br>3.0   | 9.5<br>9.5  | ns    |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time ('F541)                 | 1.5<br>1.5 | 3.4<br>2.9 | 6.0<br>5.5  |   |             | 1.5<br>1.5   | 6.5<br>6.0  |       |

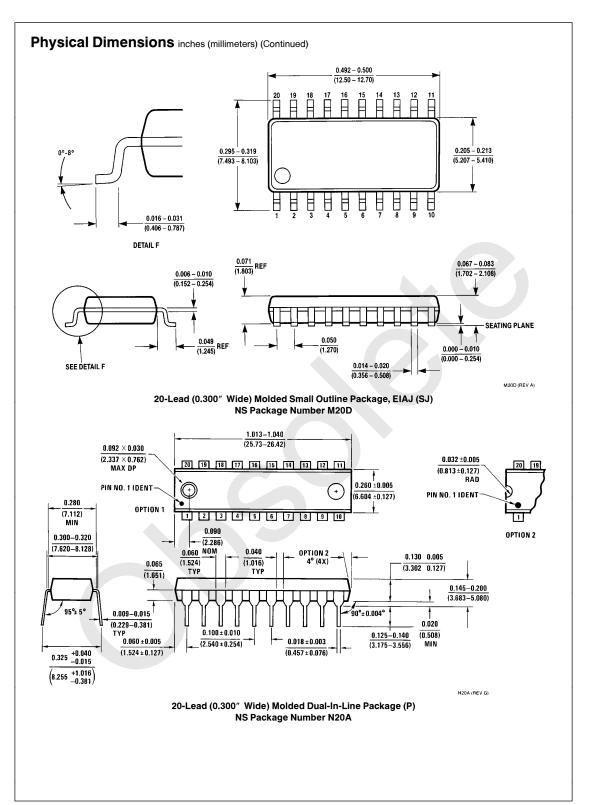
# **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

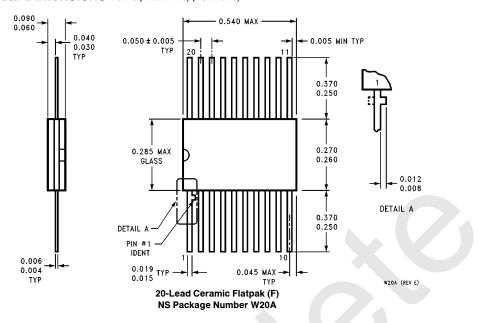








# Physical Dimensions inches (millimeters) (Continued)



#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor National Semiconductor Corporation 2900 Semiconductor Drive P.O. Box 58090 Santa Clara, CA 95052-8090 Tel: 1(800) 272-9959 TWX: (910) 339-9240

National Semiconductor GmbH Livry-Gargan-Str. 10 D-82256 Fürstenfeldbruck

Germany Tel: (81-41) 35-0 Telex: 527649 Fax: (81-41) 35-1 Japan Ltd.
Sumitomo Chemical
Engineering Center
Bldg. 7F
1-7-1, Nakase, Mihama-Ku
Chiba-City,
Ciba Prefecture 261 Japan Ltd

National Semiconductor Hong Kong Ltd. 13th Floor, Straight Block, Ocean Centre, 5 Canton Rd. Tsimshatsui, Kowloon Hong Kong Tel: (852) 2737-1600 Fax: (852) 2736-9960

National Semiconductores Do Brazil Ltda. Rue Deputado Lacorda Franco 120-3A Sao Paulo-SP Brazil 05418-000 Tel: (55-11) 212-5066 Telex: 391-1131931 NSBR BR Fax: (55-11) 212-1181

National Semiconductor (Australia) Pty, Ltd. Building 16 Business Park Drive Monash Business Park University Monash Business Park Nottinghill, Melbourne Victoria 3168 Australia Tel: (3) 558-9999 Fax: (3) 558-9998

#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products | Applications |
|----------|--------------|
|----------|--------------|

Audio www.ti.com/audio Communications and Telecom www.ti.com/communications **Amplifiers** amplifier.ti.com Computers and Peripherals www.ti.com/computers dataconverter.ti.com Consumer Electronics www.ti.com/consumer-apps **Data Converters DLP® Products** www.dlp.com **Energy and Lighting** www.ti.com/energy DSP dsp.ti.com Industrial www.ti.com/industrial Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical Interface interface.ti.com Security www.ti.com/security

Logic logic.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Power Mgmt power.ti.com Transportation and Automotive www.ti.com/automotive
Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID <u>www.ti-rfid.com</u>

OMAP Mobile Processors <u>www.ti.com/omap</u>

Wireless Connectivity www.ti.com/wirelessconnectivity

TI E2E Community Home Page e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated